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heterostructures: first-principles prediction† Son T. Nguyen, ^a Chuong V. Nguyen, ^b* Huynh V. Phuc, ^c Nguyen N. Hieu ^{de}

Achieving ultra-low contact barriers in MX₂/SiH

(M = Nb, Ta; X = S, Se) metal-semiconductor

and Cuong Q. Nguyen (1)*de

Minimizing the contact barriers at the interface, forming between two different two-dimensional metals and semiconductors, is essential for designing high-performance optoelectronic devices. In this work, we design different types of metal-semiconductor heterostructures by combining 2D metallic MX_2 (M = Nb, Hf; X = S, Se) and 2D semiconductor SiH and investigate systematically their electronic properties and contact

characteristics using first principles calculations. We find that all the MX_2/SiH (M = Nb, Ta; X = S, Se) heterostructures are energetically stable, suggesting that they could potentially be synthesized in the future. Furthermore, the generation of the MX₂/SiH metal-semiconductor heterostructures leads to the formation of the Schottky contact with ultra-low Schottky barriers of a few tens of meV. This finding suggests that all the 2D MX₂ (M = Nb, Ta; X = S, Se) metals act as effective electrical contact 2D materials to contact with the SiH semiconductor, enabling electronic devices with high charge injection efficiency. Furthermore, the tunneling resistivity of all the MX_2/SiH (M = Nb, Ta; X = S, Se) MSHs is low, confirming that they exhibit high electron injection efficiency. Our findings underscore fundamental insights for the design of high-performance multifunctional Schottky devices based on the metal-semiconductor MX₂/SiH

heterostructures with ultra-low contact barriers and high electron injection efficiency.

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Introduction

Recently, two-dimensional (2D) materials, including graphene,1 transition metal dichalcogenides (TMDCs),² phosphorene³ and MXenes,4 have garnered significant interest in the scientific community owing to their intriguing physical properties. Among these 2D materials, considerable attention has recently been directed towards TMDCs owing to their versatility in physical properties. Most TMDC 2D materials, such as MoS₂, ² MoSe₂,⁶ WS₂,⁷ and WSe₂,⁸ exhibit semiconducting characteristics. Unlike these semiconductors, NbS₂, NbSe₂, TaS₂ and TaSe₂ monolayers exhibit metallic behaviors. Recently, it has been discovered that these 2D metals serve as effective electrodes when integrated with other 2D semiconductors, facilitating the creation of metal/semiconductor heterostructures (MSHs) with

significantly reduced contact barriers.9-12 For instance, Fu et al.9 successfully grew high-quality and clean NbS2/MoS2 MSH via one-step chemical vapor deposition (CVD). Tsoutsou et al.11 demonstrated that the TaSe2 monolayer could form low barrier contacts with other semiconductors, including HfSe2 and MoSe₂ due to the small difference in their work functions. Using first-principles prediction, Nguyen et al. 12 found that integrating 2D metallic TaSe2 with semiconducting WSe2 monolayers leads to the creation of TaSe₂/WSe₂ MSH with small resistivity, having great potential for the fabrication of novel Schottky devices. The search for appropriate 2D semiconductors to contact with 2D MX_2 (M = Nb, Ta; X = S, Se) monolayers is intensifying in recent years as researchers aim to uncover ideal combinations for enhancing electronic and optoelectronic device applications.

More recently, silicane (SiH), a novel 2D material has been predicted by full hydrogenation of monolayer silicene on both sides.13,14 It should be noted that silicane can also be synthesized by mechanical exfoliation, a strategy that has been used to obtain germanane (GeH).15 Additionally, hydrogenation opens a band gap, stabilizes the structure and eliminates conductivity in the silicene monolayer.16 Moreover, the electronic, thermoelectric and optical properties of the SiH monolayer are sensitive to external conditions, including strains, 17 electric fields 18 and constructing heterostructures. 19-22 Among those strategies, construction of heterostructures has been proven to be one of the most effective strategies to enhance the physical properties

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of the SiH monolayer. For instance, we previously investigated the electronic properties and carrier mobility of the BP/SiH heterostructure as well as the effect of an electric field. The combination of SiH and BP monolayers gives rise to an enhancement in the optical absorption and carrier mobility compared to the constituent monolayers. Sheng *et al.*²³ combined the InSe/SiH heterostructure and demonstrated that such combination leads to an enhancement of photocatalytic efficiency. Furthermore, the combination between SiH and PtSe₂ (ref. 24) or AlAs²⁵ also leads to an enhancement in the absorption coefficient and photocatalytic properties. It is found that the physical properties of the SiH material can be tuned

when it is combined with other 2D semiconductors. However, to

date, the combination between SiH and other 2D metals has not

In this work, we design MX_2/SiH MSHs (M = Nb, Ta; X = S, Se) by stacking the 2D MX_2 (M = Nb, Ta; X = S, Se) metals above on top of the SiH semiconductor using first-principles calculations. It is demonstrated that all the 2D MX_2/SiH (M = Nb, Ta; X = S, Se) metal-semiconductor heterostructures form the Schottky contact with ultra-low contact barriers of a few tens of meV. Our findings could provide fundamental insights and open an avenue for the design of high-performance multifunctional Schottky devices based on the metal-semiconductor MX_2/SiH heterostructures with ultra-low contact barriers and high electron injection efficiency.

2 Computational methods

vet been extensively investigated.

Our calculations, including geometric optimization and the calculations of the interface properties, were carried out using density functional theory (DFT) as implemented in the simulation Quantum Espresso package.26 The electron exchange and correlation energy were described using the generalized gradient approximation (GGA) within the Perdew-Burke-Ernzerhof (PBE) formulation.27 For more accurate results, the hybrid Heyd-Scuseria-Ernzerhof (HSE06) functional was employed to calculate the band gap of the 2D semiconductor.28 Furthermore, the longrange interactions that may exist in layered 2D materials were described by adding the DFT-D3 method.29 A vacuum thickness of 27 Å was added along the thickness of the heterostructures to avoid any spurious interactions. All atomic positions were relaxed until the energy and forces converged to 10⁻⁶ eV and 0.01 eV Å^{-1} , respectively. The cut-off energy of 520 eV and a kpoint mesh of $9 \times 9 \times 1$ were used for all the calculations. It should be noted that the cut-off energy was gradually increased until the total energy converged to within a tolerance of less than 0.01 eV Å^{-1} . Whereas, we used such k-point grids that balanced accuracy and computational cost, ensuring that the electronic structure calculations remained precise with changes in total energy below 0.01 eV \mathring{A}^{-1} .

3 Results and discussion

We first examine the atomic structures and electronic properties of 2D MX_2 (M = Nb, Ta; X = S, Se) metals and the SiH semiconductor. The atomic structures and band structures of

these 2D materials are depicted in Fig. 1. The SiH monolayer exhibits a hexagonal atomic arrangement with a buckled structure, as illustrated in Fig. 1(a). The hydrogen atoms are passivized on both sides of silicon atoms. The lattice constant of the SiH monolayer is obtained as 3.86 Å, which is consistent with previous reports. Similarly, the MX_2 (M = Nb, Ta; X = S, Se) monolayers also possess a hexagonal structure. One transition M (M = Nb, Ta) metal is sandwiched between two different chalcogenide X (X = S, Se) atoms on both sides. The lattice constants of NbS2, NbSe2, TaS2 and TaSe2 monolayers are calculated to be 3.31, 3.43, 3.31 and 3.44 Å, respectively. These values are also close to the experimental measurements and theoretical reports. Furthermore, we investigate the band structures of all the MX_2 (M = Nb, Ta; X = S, Se) metals and the SiH semiconductor, as illustrated in Fig. 1(b). All the MX₂ materials exhibit metallic characteristics with the band crossing the Fermi level. On the other hand, the SiH monolayer shows semiconducting behavior with an indirect band gap. The maxima of valence bands (VBM) and minima of conduction bands (CBM) of the SiH monolayer are located at the Γ and M point, respectively. The band gap of SiH is predicted to be 2.18 and 2.96 eV, as measured using PBE and HSE approaches, respectively. Moreover, the Fermi level of the SiH semiconductor is closer to the VBM than the CBM, indicating that the SiH monolayer is a p-type extrinsic semiconductor. Our results are in good agreement with previous predictions. 25,30

We further design the MX₂/SiH MSHs by vertically stacking the 2D MX₂ metals above on top of the 2D SiH semiconductor. The atomic structures of the MX₂/SiH MSHs are depicted in Fig. 2 and S1 of the ESI.† We investigated four different stacking patterns (SP) of the MX₂/SiH MSHs. The most energetically favorable SP is depicted in Fig. 2. To minimize the effects of strain caused by the lattice mismatch between the two different layers, the MX₂/SiH MSHs are designed by using (2×2) and $(\sqrt{3} \times \sqrt{3})$ supercells of MX₂ and SiH layers, respectively. The overall lattice mismatch for the MX₂/SiH MSHs is less than 2%. This value is still small and affects insignificantly the electronic properties of these 2D materials. After geometric optimization, the interlayer distances between the MX₂ and SiH layers are obtained and listed in Table 1. The interlayer distances vary from 2.31 Å for the TaS₂/SiH to 2.33 Å for the NbS₂/SiH and to 2.37 Å for the TaSe₂/SiH and to 2.39 Å for the NbSe₂/SiH MSHs. This finding indicates that the interlayer distances in Nb(Ta)S₂/ SiH are shorter than those in the Nb(Ta)Se₂/SiH MSH. In addition, we can find that these values of the interlayer distances in MX₂/SiH heterostructures are comparable to those in other SiH-based heterostructures, such as AlAs/SiH,25 SiH/ CdI₂ (ref. 31) and InSe/SiH.²³ Furthermore, we check the stability of all the MX₂/SiH MSHs by calculating the binding energy as follows:

$$E_{\rm b} = \frac{E_{\rm MSH} - E_{\rm M} - E_{\rm H}}{A} \tag{1}$$

Here, $E_{\rm MSH}$, $E_{\rm M}$ and $E_{\rm H}$ are the total energies of the heterostructure, isolated MX_2 metal and the SiH semiconductor, respectively. The binding energies of all the MX_2/SiH MS-vdWHs (M = Nb, Ta; X = S, Se) MSHs are listed in Table 1.

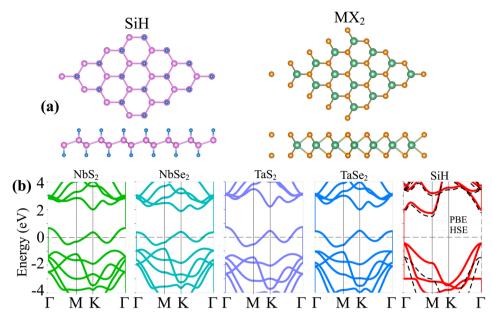


Fig. 1 (a) Top and side views of the atomic structures and (b) band structures of monolayers SiH and MX_2 (M = Nb, Ta; X = S, Se). The Fermi level is set to be zero

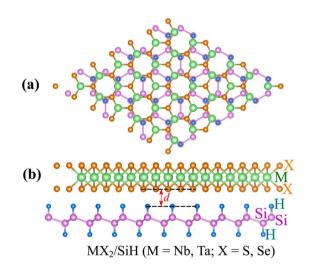


Fig. 2 (a) Top view and (b) side views of the atomic structures of the MX_2/SiH MS-vdWHs (M = Nb, Ta; X = S, Se).

Table 1 Calculated lattice constant (a, Å), interlayer distance (d, Å), binding energy ($E_{\rm b}$, meV Å⁻²), contact barriers $\Phi_{\rm p}$ and $\Phi_{\rm n}$, eV and contact type in the MX₂/SiH MSHs (M = Nb, Ta; X = S, Se) MSHs

	a, Å	d, Å	$E_{\rm b}$, meV ${\rm \mathring{A}}^{-2}$	Φ_{p} , eV	$\Phi_{\rm n}$, eV	Contact types
NbS ₂ /SiH	6.62	2.33	-14.50	0.010	2.15	p-ShC
NbSe ₂ /SiH	6.80	2.39	-12.61	0.024	2.15	p-ShC
TaS ₂ /SiH	6.63	2.32	-14.17	0.014	2.14	p-ShC
TaSe ₂ /SiH	6.81	2.37	-12.72	0.067	2.12	p-ShC

These values are comparable with those in other combined heterostructures. ^{23,32} In addition, a negative binding energy suggests that all the MX_2/SiH MS-vdWHs (M = Nb, Ta; X = S, Se)

MSHs are energetically stable, suggesting that these MSHs could potentially be synthesized in the future *via* epitaxial growth³³ or chemical vapor deposition.^{9,34}

The projected band structures of the MX_2/SiH (M = Nb, Ta; X = S, Se) MSHs are depicted in Fig. 3(a). One can find that the band structures of the MX₂/SiH MSHs appear to be a sum of the band structures of the constituent MX2 metal and SiH semiconductor. More interestingly, the combination between MX₂ metals and the SiH semiconductor leads to generation of metal/ semiconductor heterostructures. Depending on the position of the band edges of the semiconductor relative to the Fermi level of metal, the combined heterostructure can form either the Schottky contact (ShC) or ohmic contact (OhC), as illustrated in Fig. 3(b). By analyzing the projected band structures, we observe that all the MX_2/SiH (M = Nb, Ta; X = S, Se) MSHs lead to generation of the Schottky contact. In the band structures of the MX_2/SiH (M = Nb, Ta; X = S, Se) MSHs, the Fermi level of the MX2 metal lies between the band edges of the SiH semiconductor. In addition, we find that the VBM of the SiH semiconductor is closer to the Fermi level than its CBM, indicating that all the MX_2/SiH (M = Nb, Ta; X = S, Se) MSHs exhibit the ptype Schottky contact. The Schottky contact barriers for the ptype and n-type Schottky contact (ShC) can be obtained as: $\Phi_{\rm p}$ $= E_{
m F}$ - $E_{
m VBM}$ and $\Phi_{
m n} = E_{
m CBM}$ - $E_{
m F}$, where $E_{
m VBM}$ and $E_{
m CBM}$, respectively, are the energy of the VBM and CBM of the semiconductor SiH. E_F is the Fermi level of the MX₂/SiH heterostructure. The contact barriers for the MX2/SiH MSHs are listed in Table 1. It is interesting that the p-type Schottky barriers in all the MX_2/SiH (M = Nb, Ta; X = S, Se) MSHs are ultra-low. The NbS₂/SiH MSH shows the smallest p-type Schottky barrier of 10 meV, while the largest Schottky barrier is observed in the TaSe₂/ SiH MSH, which is only 67 meV. The observed ultra-low contact barrier in the MX_2/SiH (M = Nb, Ta; X = S, Se) MSHs indicates

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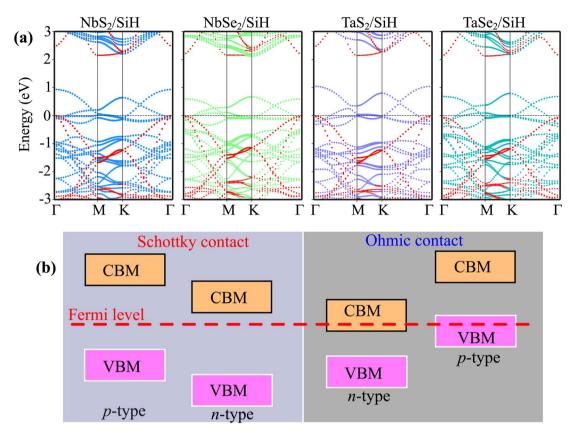


Fig. 3 (a) Projected band structures of the MX_2/SiH MS-vdWHs (M = Nb, Ta; X = S, Se) and (b) the schematic model of the band alignment in MS-vdWHs. Red, cyan, green, purple and dark-blue circles represent the contributions of the SiH, NbS₂, NbSe₂, TaS₂ and TaSe₂ layers, respectively.

that the charge injection efficiency in these heterostructures is highly advantageous.^{35,36} Thereby, the 2D MX₂ metals act as effective electrical contact 2D materials to contact with the SiH semiconductor, enabling electronic devices with high charge injection efficiency.

Furthermore, to examine the charge injection efficiency of all the MX_2/SiH MSHs, we calculate the tunneling probability and contact tunneling resistivity as follows:³⁷

$$\mathscr{T}_{\rm TB} = \exp\left(\frac{-2w_{\rm TB}\sqrt{2m_{\rm e}\Phi_{\rm TB}}}{\hbar}\right) \tag{2}$$

and

$$\rho_{t} = \frac{4\pi^{2}\hbar w_{\text{TB}}^{2}}{e^{2}} \times \frac{\exp\left[\frac{2(2m_{\text{e}})^{1/2}}{\hbar}w_{\text{TB}}\Phi_{\text{TB}}^{1/2}\right]}{\frac{(2m_{\text{e}})^{1/2}}{\hbar}w_{\text{TB}}h_{\text{TB}}^{1/2} - 1}$$
$$= \frac{8\pi^{2}\hbar^{2}w_{\text{TB}}}{3e^{2}\sqrt{2m_{\text{e}}}\Phi_{\text{TB}}} \times \mathcal{F}^{-1}$$

The w_{TB} and Φ_{TB} represent the tunneling width and tunneling height, which can be obtained by analyzing the electrostatic potential of the considered heterostructures. The electrostatic potentials of all the MX₂/SiH (M = Nb, Ta; X = S, Se) MSHs are depicted in Fig. 4. The obtained tunneling probability and contact tunneling resistivity of all the MX₂/SiH (M =

Nb, Ta; X = S, Se) MSHs are listed in Table 2 and illustrated in Fig. 5. One can find that a higher tunneling probability is correlated with lower tunneling resistivity38 and enhanced electron injection. The tunneling probability of the NbSe₂/SiH MSH is higher than that of the other heterostructures, suggesting that the NbSe2 2D metal acts as a superior electrical contact 2D material to contact with the SiH semiconductor to achieve high charge injection efficiency. Additionally, we find that the tunneling resistivity of all the MX_2/SiH (M = Nb, Ta; X = S, Se) MSHs is as low as that of the low-contact-resistance Bi/ MoS2.39,40 A lower tunneling resistivity correlates with a higher electron injection efficiency. Therefore, the electron injection efficiency in all the MX2/SiH MSHs is high. These findings suggest that the MX₂ 2D metals can act as promising electrodes for sub-10 nm field-effect transistors.41 Additionally, the work functions of NbS2, NbSe2, TaS2 and TaSe2 2D metals are calculated to be 6.12, 5.90, 5.51 and 5.36 eV. It is obvious that the work function of the MX₂ monolayers is still higher than that for the common electrode graphene (4.6 eV).42 The large value of the work functions in the MX2 2D metals leads to an alignment towards the VBM of the 2D SiH semiconductor, forming a p-type Schottky contact.43

In addition, as illustrated in Fig. 4, we can see that the potential of the SiH layer is higher than that of the NbS(Se)₂ layer in their corresponding MSHs, but it is deeper than the potential of the TaS(Se)₂ layer. The charges flow from the layer with a deeper potential to the layer with a higher one. Therefore,

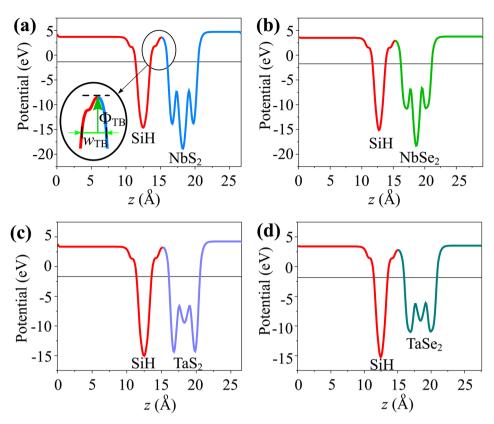


Fig. 4 Calculated electrostatic effective potentials of (a) NbS₂/SiH, (b) NbSe₂/SiH, (c) TaS₂/SiH and (d) TaSe₂/SiH MSHs.

Table 2 Calculated tunneling barrier width (w_{TB}) and height (Φ_{TB}) , tunneling probability \mathscr{T}_{TB} and contact tunneling resistivity of all the MX₂/SiH (M = Nb, Ta; X = S, Se) MSHs

	w _{TB} , Å	Φ_{TB} , eV	$\mathscr{T}_{\mathrm{TB}},$ %	$ ho_{\rm t}$, $10^{-9}~\Omega~{ m cm}^2$
NbS ₂ /SiH	3.57	3.73	3.90	5.83
NbSe ₂ /SiH	2.90	4.17	4.60	5.06
TaS ₂ /SiH	3.23	4.15	3.40	6.84
TaSe ₂ /SiH	2.78	4.32	3.80	6.14

electrons are transferred from the NbS(Se) $_2$ layer to the SiH layer in the NbS(Se) $_2$ /SiH MSH. On the other hand, charges will flow from SiH to the TaS(Se) $_2$ layer in the TaS(Se) $_2$ /SiH MSH.

We further calculated the charge density difference (CDD) in the MX₂/SiH (M = Nb, Ta; X = S, Se) MSHs to visualize the charge redistribution and charge transfer between the two constituent monolayers. The CDD in the heterostructure can be obtained from the difference in the charge densities of the heterostructure ($\rho_{\rm MSH}$) and the constituent metal ($\rho_{\rm M}$) and semiconductor ($\rho_{\rm S}$) as follows:

$$\Delta \rho = \rho_{\text{MSH}} - \rho_{\text{M}} - \rho_{\text{S}} \tag{3}$$

The amount of charge transfer at the interface of MX_2/SiH MSHs is obtained as:^{44,45}

$$\Delta Q(z) = \int_{-\infty}^{z} \Delta \rho(z') dz'$$
 (4)

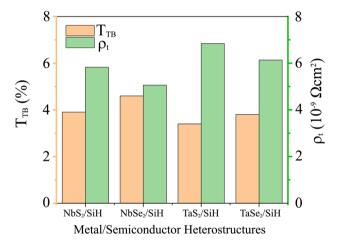


Fig. 5 Calculated tunneling probability and contact tunneling resistivity of all the MX_2/SiH (M = Nb, Ta; X = S, Se) MSHs.

The CDD for all the MX_2/SiH (M = Nb, Ta; X = S, Se) MSHs is depicted in Fig. 6. Yellow and cyan regions indicate positive and negative charges, respectively. For the NbS_2/SiH heterostructure, the positive charges are mainly accumulated in the NbS_2 layer, while the negative charges are depleted in the SiH layer, as depicted in Fig. 6(a) and its inset. This finding indicates that the electrons are transferred from the NbS_2 layer to the SiH layer, *i.e.* the metallic NbS_2 layer loses electrons, while the semiconducting SiH layer gains them. A similar trend of charge

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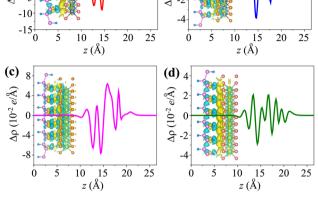


Fig. 6 The planar-averaged CDD of the (a) NbS $_2$ /SiH, (b) NbS $_2$ /SiH, (c) TaS $_2$ /SiH and (d) TaS $_2$ /SiH MSHs. Yellow/cyan indicates the contribution of the charge accumulation/depletion. The insets show the 3D isosurfaces of the MSHs.

transfer is also observed in the NbSe₂/SiH MSH, as illustrated in Fig. 6(b). On the other hand, for the TaS(Se)2/SiH MSH, the positive charges are mainly accumulated on the side of the SiH layer, while the negative charges are depleted in the TaS(Se)₂ layer. The electrons are transferred from the SiH layer to the TaS(Se)₂ layer. From eqn (5), the amount of charge transfer at the interfaces of the NbS₂/SiH, NbSe₂/SiH, TaS₂/SiH and TaSe₂/ SiH heterostructures is calculated to be 0.045, 0.012, 0.024 and 0.015e, respectively. Such amount of charge transfer is small, indicating that weak interactions are dominant at the interface of heterostructures. Furthermore, it should be noted that owing to the ultra-low Schottky barriers, the contact barriers and contact types in the MX2/SiH MSHs can be easily tuned by external conditions. 46-51 For instance, applying a compressive strain of -3% includes a transition from Schottky to the ohmic contact in the NbS₂/SiH heterostructure, as illustrated in Fig. S2 of the ESI.† The versatility in the contact behavior of the MX₂/ SiH MSHs under external conditions makes them promising candidates for next-generation multifunctional devices.

4 Conclusions

In summary, we have investigated the atomic structures, electronic properties and the formation of ultra-low contact barriers in the MX_2/SiH (M = Nb, Ta; X = S, Se) MSHs using first-principles calculations. All the MX_2/SiH (M = Nb, Ta; X = S, Se) MSHs are energetically stable, suggesting that these MSHs could potentially be synthesized in the future. More interestingly, the generation of the MX_2/SiH metal-semiconductor heterostructures leads to the formation of the Schottky contact with ultra-low Schottky barriers of a few tens of meV. This finding suggests that all the 2D MX_2 (M = Nb, Ta; X = S, Se) metals act as effective electrical contact 2D materials to contact with the SiH semiconductor, enabling electronic devices with

high charge injection efficiency. Furthermore, the tunneling resistivity of all the MX_2/SiH (M=Nb, Ta; X=S, Se) MSHs is low, confirming that they exhibit high electron injection efficiency. Our findings underscore fundamental insights for the design of high-performance multifunctional Schottky devices based on the metal–semiconductor MX_2/SiH heterostructures with ultra-low contact barriers.

Data availability

The data that support the findings of this study are available from the corresponding author upon reasonable request.

Conflicts of interest

There are no conflicts to declare.

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